

* Records of Revision *

Rev.	Page	Description of changes	Date	prepared by
0	All	Original Release	09.12.23	Little Fan

√ 一般事项 特殊事项内容:	□ 特殊事项		

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1. Features

The features of BTL221722-276L are as follows

* Display mode : TFT 262K Colors, Transmissive, Normally White

* Driving Condition : 176x3Ch-Source / 220Ch-Gate

* Connection : Soldering Type

* LCD Driver & Control IC

: HX8340B(N) (Himax)

* Back Light : White LED Back Light (3 Chips in Parallel)

* MPU Interface : Serial Peripheral Interface

* Type of Surface Condition

: Clear Type

2. Mechanical Specifications

Item		Specification	Unit	
Resolution	Main	176(x RGB) x 220	Dot	
Resolution	Sub	NA	Dot	
LCM Outline Deme	nsion	40.3x55.26x2.35(without D/A tape)	mm	
Active Area (M × H)	Main	34.848X43.56		
Active Area (W × H)	Sub	NA	mm	
Divol Ditab (M v H)	Main	0.066X0.198	mm	
Pixel Pitch (W x H)	Sub	NA	mm	
Viewing Direction	Main	6	O'clock	
(Human Eye)	Sub	NA	O Clock	
Gray Scale Inversion	Main	12	O'clock	
Direction (Contrast Ratio)	Sub	NA	(Rubbing Direction)	
Weight		About 12	g	

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3. Absolute Maximum Ratings

(Ta=25[°]C Note1)

Items	Symbol	Min.	Max.	Unit	Remark
Logic voltage	I _{ovcc}	-0.3	3.6	V	
Analoge voltage	V _{CI}	-0.3	4.2	V	
Input signal voltage	V _{IN}	-0.3	lovcc+0.5	V	
LED forward current	I _{LED}	-	25	mA	For each LED
Operation temeprature	T _{OPR}	-20	70	${\mathbb C}$	
Storage temperature	T _{STG}	-30	80	${\mathbb C}$	
Humidity (ambient temeprature=Ta)		Ta ≤60℃	90% I	RH Max.	

Note1: Device is subject to be damaged permanently,

if stresses beyond those absolute maximum ratings listed above.

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4. Electrical Characteristics

Main Ta=25 $^{\circ}$ C

Iten	าร	Symbol	Min.	Тур.	Max.	Unit	Remark
Logic voltage		l _{ovcc}	1.65	2.8	3.3	٧	
Anolog(Power) voltage		V _{cc}	2.72	2.8	2.88	٧	
Gate voltage	High level	V_{GH}	12	-	18	٧	Note 1
	Low level	V_{GL}	-11	-	-7	٧	
Input signal	High level	V _{IH}	0.7×lovcc	-	lovcc	٧	
voltage	Low level	V_{IL}	VSSD	-	0.3×lovcc	٧	
current con	sumption	lcc	-	3	5	mA	Note 2

Note 1) The value can be adjusted by software to optimize display quality

Note 2) Display Black Pattern

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5. Recommended Software Setting Value (LDI: HX8340B(N))

Initial Code

Initial Code				
INDEX	DATA	INDEX	DATA	
Powe	er On		0x07	
100ms de	elay or more		0x05	
Hardwa	re Reset		0x33	
50ms dela	ay or more	10ms dela	ay or more	
0xC1	0xFF	0xB5	0x35	
	0x83		0x20	
	0x40		0x45	
0x11		0xB4	0x33	
150ms de	lay or more		0x25	
0xCA	0x70		0x4C	
	0x00	10ms dela	ay or more	
	0xD9	0x3A	0x05	
0xB0	0x01	Display C	N Setting	
	0x11	0x29	-	
Driving ab	ility Setting	10ms delay or more		
0xC9	0x90	Set GRAM Area		
	0x49	0x2A	0x00	
	0x10		0x00	
	0x28		0x00	
	0x28		0xAF	
	0x10	0x2B	0x00	
	0x00		0x00	
	0x06		0x00	
20ms dela	ay or more		0xDB	
	2.2 Setting		AM write	
0xC2	0x60	0x2C	Display Data	
	0x71			
	0x01			
	0x0E			
	0x05			
	0x02			
	0x09			
	0x31			

0x0A

0x67 0x30 0x61 0x17 0x48

0xC3

Into Sleep Mode

INDEX	DATA			
0x28				
10ms dela	y or more			
0x10				
120ms delay or more				

Exit Sleep Mode

INDEX	DATA			
0x29				
10ms delay or more				
0x11				
120ms delay or more				

Windows Display Setting

INDEX	DATA
0x2A	Start Column
	Start Column
	End Column
	End Column
0x2B	Start Row
	Start Row
	End Row
	End Row

Note: R3Ah=0x06 ,262K colors R3Ah=0x05 ,65K colors

NOTE: BOE requires the customer to follow the above instructions strictly. If customer would like to change the above instructions, the customer should inform BOE and get re-check from BOE, or the customer will be responsible for any unexpected result because of the change.

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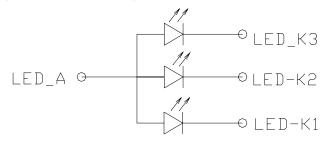
6. Back Light System Characteristics

Ta=25°C

Items	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward current	lf	-	18	20	mA	Note1
Forward voltage	Vf	3.0	-	3.4	V	Note1
B/L Power consumption	P_{BL}		ı	205	mW	Note2

Note 1: The Driving conditon is defined for each LED chip.

Note 2: The B/L Power consumption is defined for the backlight module the schematic drawing of the backlight module as the figure.



Ref. Total power consumpation(max) depends on LED current/ LED driver efficiency, etc.

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7. Optical Characteristics

Transmissive Mode

Ta=25℃

It	tem	Sy	mbol	Min.	Тур.	Max.	Unit	Condition	Note
			Ø=0° (X1)	1	45	1			
Viouring Anglo	θ	Ø=180° (X2)	1	45	=	d	Cr > 10	Note2	
VIEWI	Viewing Angle	U	Ø=90° (Y1)	1	35	-	deg.	01 > 10	NOIGZ
			Ø=270° (Y2)	1	15	-			
	ast ratio missive)		Cr	230	440	-	ı	$\theta = 0$ $\emptyset = 0$	Note1 Note4
Respo	nse Time	Т	r + Tf	-	25	-	ms	$\theta = 0$ $\emptyset = 0$	Note3
CIE	R		(x,y)	0.55,0.29	0.59,0.33	0.63,0.37			
Coordi	G		(x,y)	0.29,0.56	0.33,0.60	0.37,0.64		$\theta = 0$	
- nate	В		(x,y)	0.11,0.06	0.15,0.10	0.19,0.14		Ø = 0	
	W		(x,y)	0.25,0.27	0.29,0.31	0.33,0.35			
Brig	htness		L	270	340	ı	cd/m2	18mA/LED	Note5
Unif	ormity			70	-	-		18mA/LED	Note6

^{*} Ø = 0 $^{\circ}\,$, Ø = 90 $^{\circ}\,$,Ø = 180 $^{\circ}\,$,Ø = 270 $^{\circ}\,\,$ means viewing direction.

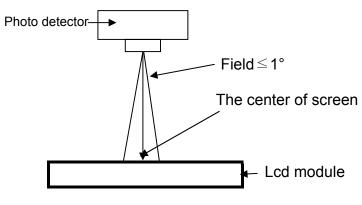
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^{*} B/L is turned on.

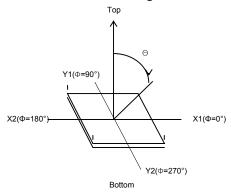


The optical characteristics should be measured in dark room, and after 5 minutes operation, the measurment begin.

Note1. Definition of Measure System

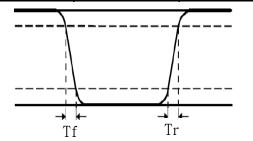


Note2. Definition of Angle O.

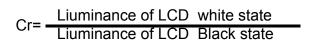


Note3. Definition of Response Time

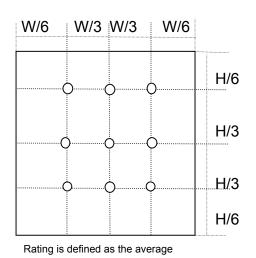
White(TFT off) Black(TFT on) White(TFT off)



Note4.definition of contrast ratio



Note 5. Measuring Point(9 Points) (WxH)



brightness inside the viewing area

Note 6. definition of Uniformity

Uniformity= max. Liuminance of measurede point max. Liuminance of measurede poin

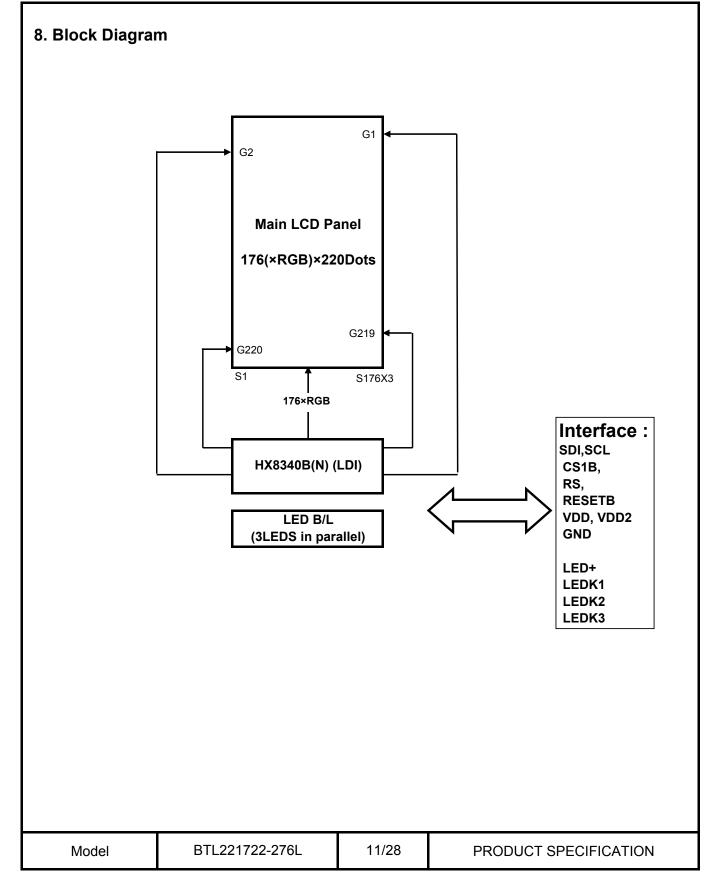
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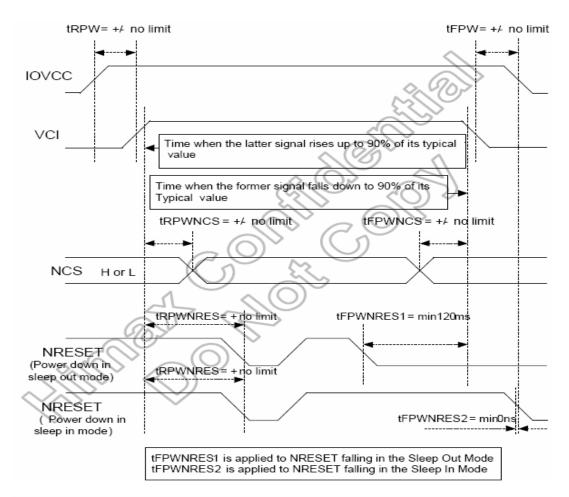
9. Interface Pin Assignment

No	Symbol	Description
1	VSS	Ground
2	NC	No Connection
3	LED+	LED Anode(+)
4	VDD2	VDD,Power Supply for Internal Logic(1.8V or 2.8V)
5	CS1B	Chip Select Signal(low active)
6	SDI	Serial data input/output PIN
7	SCL	Serial clock
8	RS	Not use(Connect to IOVCC or GND)
9	RESETB	Hardware Reset Signal
10	VDD	VCI,Power Supply 2.8V
11	LEDK1	LED Cathode(-)
12	LEDK2	LED Cathode(-)
13	LEDK3	LED Cathode(-)
14	VSS	Ground

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10. Power Supply Sequence



Power source IOVCC, VCI can be applied and powered down in any order.

IOVCC, VCI can be powered down in any order.

During power off, if LCD is in the Sleep Out mode, IOVCC, VCI must be powered down minimum 120msec after NRESET has been released.

During power off, if LCD is in the Sleep In mode, IOVCC, VCI can be powered down minimum 0msec after NRESET has been released.

NCS can be applied at any timing or can be permanently grounded. NRESET has priority over NCS.

Note: (1) There will be no damage to the display module if the power sequences are not met.

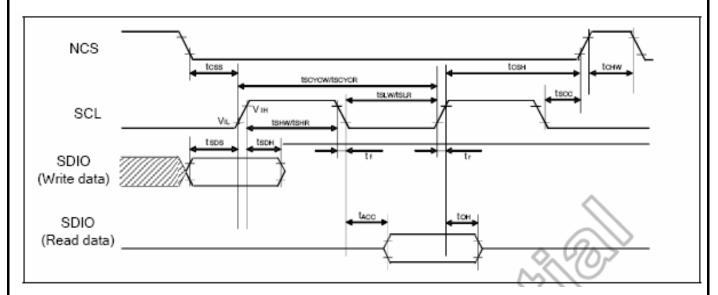
- (2) There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.
- (3) There will be no abnormal visible effects on the display between end of Power on Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.

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11. Read/Write Timing characteristics (80 series MPU)

1) Read/Write Timing



Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Serial clock cycle (Write)	tscycw	((2))	66	\wedge	-	
SCL "H" pulse width (Write)	tsnw	SCL	15	//	-	ns
SCL "L" pulse width (Write)	tsuw	Δ . (() \geq	15	2	-	
Data setup time (Write)	tsos	SDIO	40		-	ns
Data hold time (Write)	tspн	SDIO	10	>	-	115
Serial clock cycle (Read)	tscyck		150		-	
SCL "H" pulse width (Read)	tsnr	SCL	60		-	ns
SCL "L" pulse width (Read)	tsur		60		-	
Access Time	tacc	SDI for maximum C _L =30pF	10		50	ns
7100000 11110	0.00	For minimum CL=8pF				
Output disable time	ton	SDO For maximum CL=30pF	15		50	ns
<u> </u>	11 1	For minimum CL=8pF	2		3	113
SCL to Chip select	tacc	SCL, NCS	20			ns
NCS "H" pulse width	tchw	NCS	40			ns
Chip select setup time	tcss	NCS	15		-	ns
Chip select hold time	tcsn	1000	15		-	115

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.

Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.



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2) Reset Timing characteristics

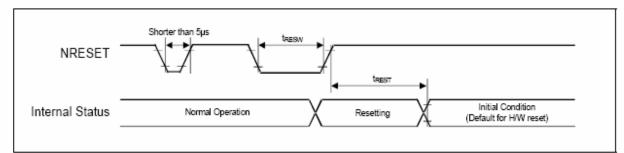


Figure 11. 6 Reset Input Timing

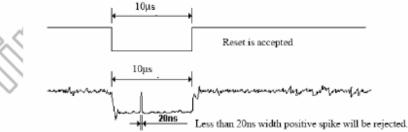
Symbol	Parameter	Related Pins	Min.	Тур.	Max.	Note	Unit
tresw	*1) Reset low pulse width	NRESET	10	-	-	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	μs
trest	*2) Reset complete time	-	-	-	5	When reset applied during Sleep In mode	ms
IKESI		-		-	120	When reset applied during Sleep Out mode	ms

Note:

1. Spike due to an electrostatic discharge on !RES line does not cause irregular system reset according to the following table.

NRESET Pulse	Action
Shorter than 5 µ	Reset Rejected
Longer than 10 µs	Reset
Between 5 µs and 10 µs	Reset Start

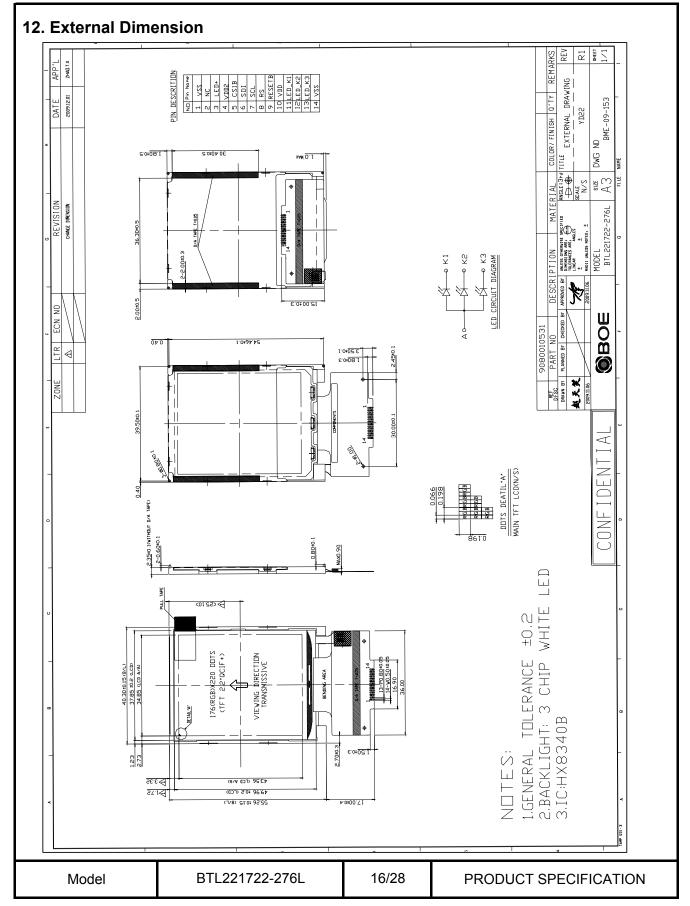
- During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.
- During Reset Complete Time, ID2 and VCOMOF value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of RESET.
- 4. Spike Rejection also applies during a valid reset pulse as shown as below:



It is necessary to wait 5msec after releasing RESET before sending commands. Also Sleep Out command cannot be sent for 120msec.

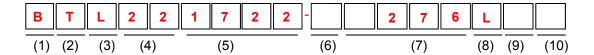
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13.COLOR LCD MODULE NUMBERING SYSTEM



(1) B: BHL

(2) Drive System

C: CSTN T: TFT E: OLED M: MONO

(3) Product Status

L: LCD Model F: FOG Model G: COG Model P: PANEL Model C: CELL Model

(4) Display size(精确到小数点后1位,四舍五入)

(5) Resolution

Number of Row Dots * Number of column Dots(前两位有效)

(6) Viewing Direction

Nil: 6 H U: 12 H L: 9 H R: 3 H W: Wide view E: 其他

- (7) Serial Number (*001-9999:按照产品状态,各类产品序列号实行大排行处理,*为0时省略不写)
- (8) Back Light

Nil:Without backlight + Reflective H:CCFL + Translective

T:Without backlight + Transflective E:LED Frontlight + Reflective

F:CCFL Frontlight + Reflective D:LED + Transflective

L:LED + Transmissive

(9)DUAL LCD

Nil: Single LCD M:MONO C:CSTN T:TFT O:OLED

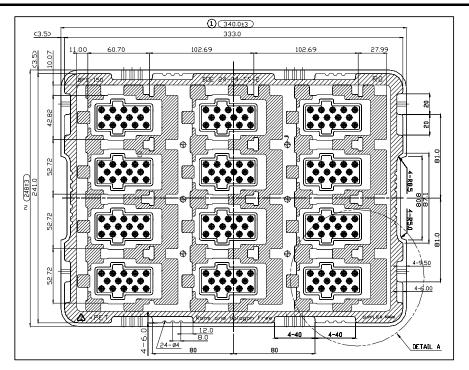
(10)TOUCH PANEL

Nil:Without TP P:with TP



14. Package Terms

1、Tray Size L:340mm W:248mm (12 PCS LCM/Tray)



Tray Drawing

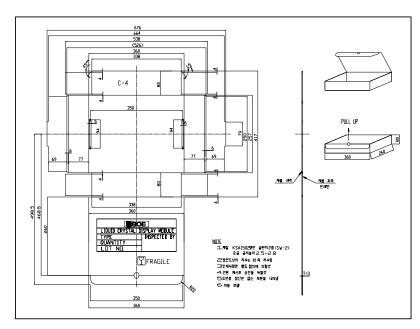
2、Inner BOX Size L:360mm

W:260mm

H:80mm

(7pcsTray/ Inner Box)

Note: there's one empty tray in every inner box.



Inner Box Drawing

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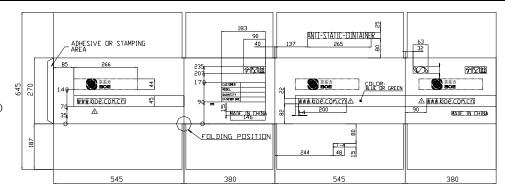


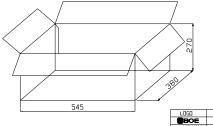
3、Out BOX Size

L: 545mm W: 380mm

H: 270mm

(6pcs Inner / Out)





NOTE

1.MATERIAL: KSA 1531,DW2(T=8mm)

2.DRAWING DIMESIONS ARE EQUAL TO DUTSIDE DIMENSION.
3.INNER BOXCC-4) ARRANGEMENT: 3STEPS X22ROWS

4.MARKS ARE REFER TO SEPERATE CONSULTATION.

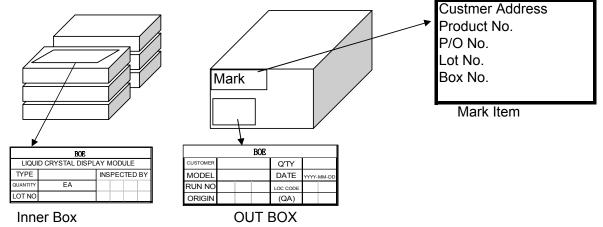
LOGO COLOR

BOE BLUE OR GREEN

WWV.BDE.COM.CN CLEARNESS

OTHERS BLUE OR GREEN

4. Packing label content



5. Packing notice

- [1]Sub LCD should be placed upwardly while in the tray.
- [2] Every seven full trays with a blank one while twining twice on both sides by adhesive tape.
- [3]. Every tray should be put crossedly.

6. Product label

[1] There should be Logo and product modle of BOE on FPC ASS'Y.

7、Packing Q'ty list

			INNER BOX	TRAY	MODULE
OUT BOX		6	42	432	
INNER BOX		1	7	72	
		TRAY	-	1	12

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15. LCD Module Out-Going Quality Level

(1.0) Purpose

The LCD specification provides outgoing provision and its expected quality level based on our outgoing inspection of LCD.

(2.0) Applicable Scope

The LCD specification is applicable to the arrangement in regard to outgoing Inspection and quality assurance after it.

(3.0) Quality Specification

(3.1) Quality Level

The quality level of BHL&BMDT are based on GB/T2828.1, Apply Level II, normal inspection by single sampling.

Rank	Item	AQL	Note
Major(MA)	Segment Short	0.65	
	Segment Missing		
	Solder Bridging		
	Outside Dimension		
	Cold Solder		
Minor (MI)	Black Spots, Foreign Substance,	1.0	
	White Spots, Pinhole, Segment Deformation		
	Air Bubbles between Glass & Polarizer,		
	Scratchs(Glass & Polarizer),		
	Color Variation, Solder Ball,		
	Misalignment		

Note) AQL- Acceptable Quality Level

(3.2) Appearance Standards

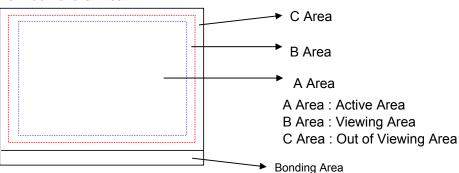
1) Inspection Conditions

The LCD shall be inspected under 20W white fluorescent lamp light.

The distance between the eyes and the sample shall be 30cm.

All directions for inspecting the sample should be within 30° to perpendicular line.

2) Definition of the Area



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(3.3) Apperance Spec

No	Item		Criteri	la		Rank	Remark
1	Segment Short	Not allowed			MA		
	Segment Missing						
2	Solder Bridging	Any bridging between components,				MA	
		except common circuit, is not allowed.					
3	Outside Dimension	Drawing & specification	Drawing & specification must be within				
		permitable tolerance.					
4	Cold Solder	Cold solder is not allow	wed.			MA	
5	Black(White)	1) Round Type				MI	
	Spots, Foreign						Y
	Substances	Area	Accepta	ible Q'ty	Remark		₩
		Dimension**	A Area	B Area			1
		≤ 0.1	Ign	ore			() \ \ \ X
		≤ 0.2	2	Ignore			<u> </u>
		≤ 0.3	1	Ignore			** : Mean
		0.3 <	0	Ignore			Diameter
							(X + Y)/2
		2) Liner Type					
		Dimension	Accepta	ıble Q'ty	Remark		
		Length Width	A Area	B Area			
		- ≤ 0.025					
		$\leq 2.5 \leq 0.05$	3	Ignore			
		$\leq 1.5 \leq 0.075$	2	Ignore			
		0.075 <	Follow re	ound type			
		At (1) & (2) total defect q'ty is must not					
	exceed 5 pieces.						
6	OC Spot					MI	
		Area		ble Q'ty	Remark		
		Dimension**	A Area	B Area			
		≤ 0.2	Ù	ore			
		≤ 0.8	3	Ignore			
		≤ 1.0	1	Ignore			
<u> </u>							4
7	Air Bubles			11 01		MI	
	Between Glass &	Area		ble Q'ty	Remark		
	Polarizer	Dimension**	A Area	B Area			
	(Polarizer Defects)		≤ 0.15 Ignore				
		≤ 0.3	3	Ignore			
		≤ 0.5	2	Ignore			
		≤ 0.7	1	Ignore			
		Total	5	Ignore			
		1					

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(3.3) Appearance Spec

No	Item	Criteria	Rank	Remark
8	Pin hole	$(X+Y)/2 \le 0.2 \text{mm}$	MI	
	(On Segment)	▼ Y Within 1 per one		
		segment (Less than 0.1mm		
		is not counted)		
		Total defects q'ty is must not exceed 5 pieces.		
		4- <i>y</i>		
9	Segment		MI	(X + Y)/2
	Deformation	I. X . I . I I. A		≤ 0.2mm
	20101111111011	$(X+Y)/2 \le 0.2 \text{mm}$		_ 0.2
		1 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2		
		$A \le 0.2 \text{mm}$ $B \le 0.2 \text{mm}$		
		$(C-D) \leq 0.2 \text{mm}$		
		(C-D) = 0.2mi		
		$\left \begin{array}{c} \leftarrow C \rightarrow \left \leftarrow D \rightarrow \right \end{array}\right $ ' B		
		Acceptable Q'ty		
		Dot, Segment 1		
		LCD 5		
		≤ 0.1 Ignore all defect		
		Each visible dot must be more than half		
		effective dot area		
10	Color Variation	Within the three colors, except LCD	MI	
		Standard color is acceptable.		
11	Glass & Polarizer	Follow NO.5(2) condition	MI	
	Scratch			
12	Solder Ball	1)Acceptable if the size of void is less	MI	
		than 0.18 mm		
		2)Acceptable if a solder ball is not movable		
		3)Rejectable if the solder ball exceed		
		5EA in 2.54 × 2.54 mm area.		
13	Miss Alignment	1)Acceptable if it dose not exceed 50% of		
		the lead width IC.		
		$X \leq W/2 : Accept$		
		\mathbb{Z}		
		IC LEAD ^{A I}		
		2)Rejectable, provided that it does		
		exceed 50% of the component		
		termination width.		
		W1 LWO		
		W1	1	

Note: A limitation sample is given top priority

	DTI 00/100 0001	00/00	
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(3.3) Appearance Spec

No	Item			Criter			Rank	Remark
14	Touch Panel	1) Round Ty	1) Round Type . Foreign Substances				MI	
			1					Y
			rea	Accepta		Remark		
			nsion**	A Area B Area				$()$ \uparrow_{X}
		≤ 0.1		Ignore				
		≤ 0.2		2	Ignore			
		≤ 0		1	Ignore			** : Mean
		0.3 <		0	Ignore			Diameter $(X + Y)/2$
		2) Liner Type & Scratch Dimension						
		Length	Width	A Area	B Area	Kemark		
			W≤0.025	Ign				
		1 < 3 0		Igne				
		1.0 <l≤5.0< td=""><td>W≤0.05</td><td>2</td><td></td><td>Ignore</td><td></td><td></td></l≤5.0<>	W≤0.05	2		Ignore		
		3.0 <l≪3.0 ≤ 7</l≪3.0 	W≤0.1	1		1811016		
		-	W>0.1					
			- W>0.1 Follow round type					
		It's NG.				f the touch panel		
		b)None-regularity						
		b)None-reg	gularity					
		b)None-reg	gularity					
				ring is more t	nan 1/2area o	f the touch panel		

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(4.0) Reliability Condition

Item	Content		
Room Temperature Operation	50,000 hrs		

(4.1) Reliability Test - Module Middle Reliability

No.	Item	Condition	Test	Sample	Creteria	Note	
			Time	Numbers	(Acc/Rej)		
1	High Temp Operation	70 ± 2℃	120 hrs	3	0/1		
2	High Temp Storage	80 ± 2℃	120 hrs	3	0/1		
3	Low Temp Operation	-20 ± 2°C	120 hrs	3	0/1		
4	Low Temp Storage	-30 ± 2°C	120 hrs	3	0/1		
5	High Humidity Storage	60℃ 90%rh	120 hrs	3	0/1		
6	Thermal Shock	-25°C (0.5h) ↔ 70°C (0.5h)	20cycle	3	0/1		
7	Vibration Test	vibrating frequen of X,Y,Z for each	To be measured after subjecting to total fixed amplitude of 1.5mm vibrating frequency 10 to 55Hz, one cycle 60 seconds to direction of X,Y,Z for each 15 minutes,(Total 45minutes) and after removing vibration(Non-operation state)				
8	Shock Test (Drop Test)	To be measured after dropping from 60cm high onto steel board of 15mm thick and from 3 direction X,Y,Z each one time					
9	ESD	 (Non-Operation State) Condition:150pf, 330Ω, ±8KV, 5 times Air Discharge (ESD which is made by above condition should be shot on LCD glass panel, not other's area(such as on IC and so on) After testing, cosmetic and electrical defects should not happen. Total current consumption should be below double of initial value. In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part. 					

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(4.2) Criteria

a. No. $1 \sim 8$: No changes for indication and appearance.

b. No. 1 \sim 3, 5 \sim 8 : Leave the all samples under room temperature 4 hours after reliability test ends.

c. No. 4 : Leave the all samples under room temperature 12 hours after reliability test ends.



16. BHL&BMDT Customer Quality Service Process

In order to provide better service to Customer, BHL&BMDT shall apply the after-sales product quality service process as below:

- 1. According to the P/O from Customer, BHL&BMDT should deliver required product to the place appointed by Customer.
- 2. Customer will do IQC for the incoming product.
- Inspection standard should be provided by BHL&BMDT, and it will be valid after confirmed by Customer.Inspection and Defects determination should be carried out according to the standard agreed by both Parties.
- 4. In order to guarantee in-time communication of product quality information and effective service, QA staff on Customer side should send Weekly Quality Report to the appointed CS staff in BHL&BMDT.
- 5. After BHL&BMDT get related information, both sides should arrange time and place to determin the defects found by Customer.
- 6. BHL&BMDT should cooperate with Customer for special quality requirement.
- 7. After confirmed by both side, BHL&BMDT should be responsible for the defect products which caused by its quality problem. BHL&BMDT should take back the confirmed defect product and return the good product to the place required by customer.
- 8. BHL&BMDT agree to provide related training of LCD product technology and usage.
- 9. Customer should use the LCD product according to the instruction. BHL&BMDT will not be responsible for the defect product caused by violation of Users' Instruction.
- 10. Both parties should deal with the quality problem with friendly cooperative policy. And both parties should negotiate to deal with the defect products of which the responsibility is not very clear.



17. LCD Module Operation Instruction

BHL&BMDT

Part I. How to use the LCD Module

- 1. Don't hit the LCD Panel in any way because the LCD is made of glass.
- 2. Don't clean the surface of LCD with hard things. Please clean LCD with Air-gun or very soft cloth when necessary. The protective film on the POL can be removed just before assembly, otherwise, dust, spit or other foreign matter may attached on the LCD under the protective film. After the protective film is removed, only air-gun can be used to remove any dust or foreign matter. Fingure or cloth MUST NOT be used in such cases.
- No chemical liquid is allowed to clean the LCD, such as alcohol, acetone and IPA. All of these can damage the LCD. Water on the LCD must be cleaned as soon as possible, for it will cause POL color change or other defect.
- 4. Please move and assemble LCD very carefully during assembly, and don't push or twist it.
- 5. Don't damage the FPC of LCD module. It will cause permanent defect.
- 6. Don't disassemble LCD module. It will cause permanent defect.
- 7. Don't expose LCD module under sunshine, strong fluorescence or ultraviolet radiation.
- 8. Please make sure that operators wear static-protective bands effectively and working tables are effectively earthing during operation.
- 9. Please place LCD module on the tray provided by BHL&BMDT while moving it, in order to avoid mechanical damage. Hold the module's side frames to avoide damage during moving.
- 10. Don't twist, disassemble, squeeze or hit the PCB. It will damage the circuit or component on PCB and cause functional defect.
- 11. Please use the connector according to the instruction provided by BHL&BMDT.
- 12. Please place dual module with the sub-panel upward. Trays should be placed in contrary direction. An empty tray should be placed on the top.
- 13. Sealing operation on PCB must be very careful to avoid short or cut the original circuit on PCB. Otherwise, it will cause permenant damage to the LCD.
- 14. Don't add direct DC or high voltage to LCD panel. It will cause functional damage to the LCD or shorten the life of LCD product.
- 15. LCD may respond slowly or display abnormally in extrem temperature (lower than -20°C or higher than 50°C). But this doesn't mean LCD functional defect. LCD will display normally in regular temperature. Therefore, don't use LCD product in extrem temperature.
- 16. Don't push the display area of LCD panel, it will cause abnormal display. This doesn't mean LCD functional defect, neither. LCD will display normally in regular temperature.
- 17. Electrical test of LCD product is made by using mobile phone provided by Customer. We can use special test equipment to do the test, also.
- 18. The black band on IC on LCD product is used to protect the IC from light. Please do NOT remove it.
- 19. Please take great care to use connector. Customer should be responsible for connector defect caused by operation on Customer side.

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Part II Storage

- 1. Physical status of liquid crystal will change in extrem temperature, and it can not be resumed when the temperature returns to be normal. So LCD module should be stored in required temperature.
- 2. LCD module should be stored in required humidity. Low hymidity may add static, while high humidity may corrode the ITO circuit of LCD product. The suitable storage environment is: temperature: 22±5°C, humidity: 55%±10%.
- 3. Don't expose LCD module under sunshine, strong fluorescence or ultraviolet radiation for a long time. It should be stored in dark area.
- 4. LCD should be stored in static-protective polythene bag. Don't expose it in the air for a long time.